

AMENDMENTS TO THE SPECIFICATION:

Please amend the title as follows:

IC Socket with a Cover Member and Guiding Members

Please amend the paragraph on page 2, lines 15-18 as follows:

Another drawback is that the projecting guide posts become a hindrance and limit the moving path of the robot when the robot holds the IC package by suction and mounts it on the IC socket.

Please amend the paragraph extending from page 8, beginning at line 20 through the top of page 9, line 10 as follows:

Next, the cover member 200 has an opening 210 square in plan view and facing the mounting portion and inclined guide wall surfaces 220 leading to the opening 210 and adapted to guide the IC package 300 onto the mounting portion. The opening 210 is so sized that two opposing sides of the opening 210 almost match with an envelope 321 joining tips of the lead terminals 320 extending from the two opposing sides of the IC package 300. An example of envelope 321 is shown in Fig. 5. In this embodiment, the lead terminals 320 extend from four sides of the IC package 300 and thus the lower edges of the four sides of the opening 210 almost match with [[the]] envelope 321 joining the tips of the lead terminals 320. For an IC package with its lead terminals extending from only two opposing sides, the size of the opening need only be set so that the lower edges of the corresponding two opposing sides of the opening almost match with the envelope 321 joining the tips of the lead terminals 320.

Please amend the paragraph extending from page 9, beginning at line 11 and through line 17 as follows:

Further, on the outer periphery of the positioning seat 140 that constitutes the mounting portion, a plurality of first contacts 125 as fixed contacts are arranged. The size of the opening is also set so that the lower edges of the two opposing sides of the opening 210 almost match with [[an]] envelope 321 joining outer ends of the first contacts 125.

Please amend the paragraph extending from page 11, beginning at line 20 through the top of page 12, line 5 as follows:

The inclined guide wall surfaces 220 lead to the opening 210, and each side of the opening 210 almost agrees with [[an]] envelope 321 joining the tips of the lead terminals 320 extending from the IC package 300 to be mounted on the socket and also with [[an]] envelope 321 joining the outer ends of the first contacts 125. Hence, the IC package 300 that has been engaged and guided by the first inclined guide wall surfaces 222 is now supported on the positioning seat 140 with the corner inclined surfaces of its body 310 abutting against the positioning projections 142 and with the lead terminals 320 precisely positioned on the first contacts 125.